

### VM090S

#### • General Description

The VM090S is a packaged power amplifier matched through 50Ω RF accesses. It can provide an output power up to 18W and associated power added efficiency of 29% in pulsed mode.

The VM090S is offered a hermetically sealed 10 leads 8 x 8 QFN designed to a surface mount design board. The QFN has a CuW base for superior thermal management. The VM090S integrates the VM090D VectraWave HPA.

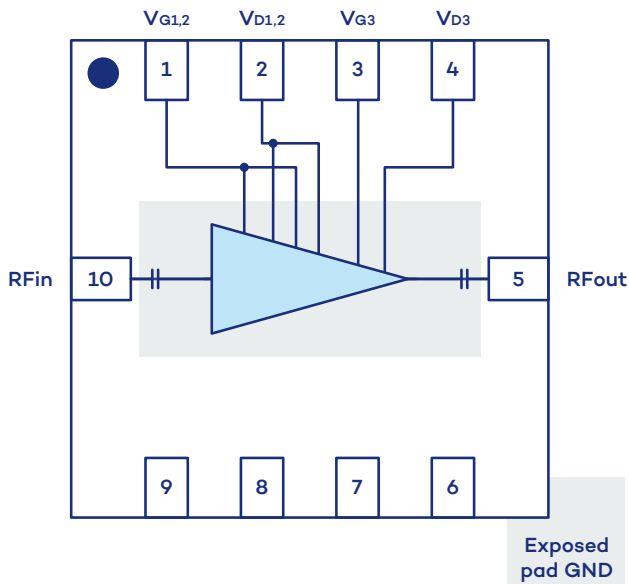
#### • Features

Frequency range	<b>8.5 – 10.5GHz</b>
Output Power	<b>42.6dBm @Pin = 23dBm</b>
PAE	<b>29% @Pin = 23dBm</b>
Linear Gain	<b>27dB</b>
DC bias	<b>V<sub>D</sub> = +28V, I<sub>DQ</sub> = 190mA, V<sub>G</sub> = -2.35V (Typical)</b>
Hermetic QFN	<b>8 x 8 (mm) 10leads</b>

#### • Applications

- Radar
- Test and Measurement

#### • Pins Assignment & Functional Block Diagram



Function	Pin number
V <sub>G1,2</sub>	1
V <sub>D1,2</sub>	2
V <sub>G3</sub>	3
V <sub>D3</sub>	4
RFout	5
NC	6
NC	7
NC	8
NC	9
RFin	10

## • Electrical Specifications

Test conditions: unless otherwise noted

- $T_{amb} = +25^{\circ}\text{C}$
- $V_D = +28\text{V}$
- $I_{DQ} = 190\text{mA}$  ( $V_G = -2.35\text{V Typ.}$ )
- Pulsed mode (pulse width:  $30\mu\text{s}$ , duty cycle: 10%)

Symbol	Parameter	Min	Typ	Max	Unit
F	Frequency range	8.5		10.5	GHz
G	Linear gain		27		dB
S11	Input return loss		-10		dB
S22	Output return loss		-12		dB
P <sub>out</sub>	Output power (@P <sub>in</sub> =23dBm)		42.6		dBm
PAE	Associated Power Added Efficiency (@P <sub>in</sub> =23dBm)		29		%
I <sub>D</sub>	Associated Drain current (@P <sub>in</sub> =23dBm)		2.4		A
V <sub>D</sub>	Drain voltage		28		V

## • Recommended Operating Conditions

Symbol	Parameter	Value	Unit
V <sub>D</sub>	Drain voltage	28	V
I <sub>DQ</sub>	Drain quiescent current	190	mA
V <sub>G</sub>	Gate voltage	-2.35 (Typ.)	V

## • Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
V <sub>D</sub>	Drain bias voltage	35	V
I <sub>D</sub>	Drain bias current	3	A
V <sub>G</sub>	Gate bias voltage	-10 to -2	V
P <sub>in</sub>	Maximum peak input power overdrive	30	dBm
T <sub>j</sub>	Junction temperature	225	°C
T <sub>a</sub>	Operating temperature range	-40/+85	°C
T <sub>stg</sub>	Storage temperature range	-55/+150	°C

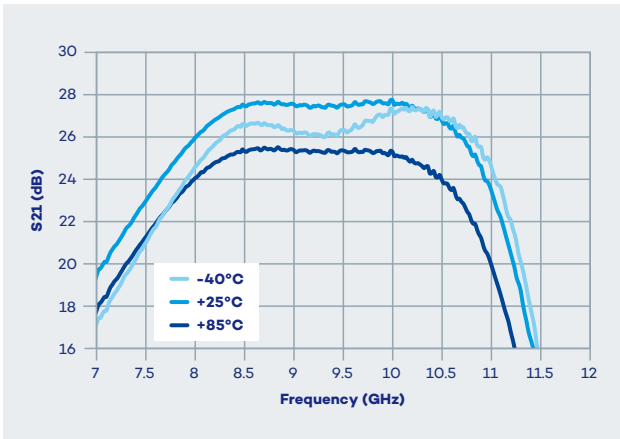
Operation of this device above any of these parameters may cause permanent damage.

• **Typical Performance**  
(Small signal / Board Measurement)

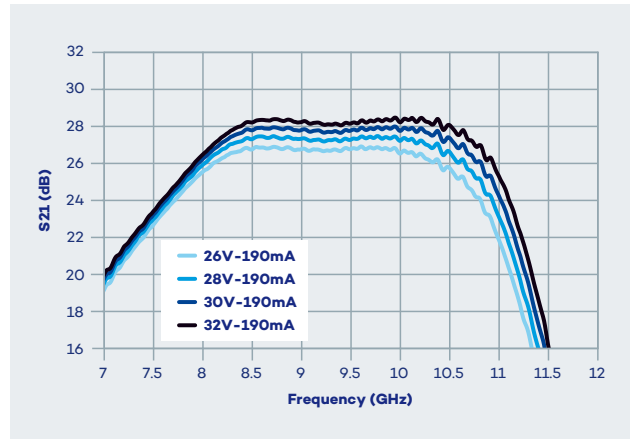
Test conditions: unless otherwise specified

- Reference plane: connector access
- $V_D = +28V$
- $I_{BQ} = 190mA$  ( $V_G = -2.35V$  Typ.)
- $P_{in} = -20dBm$

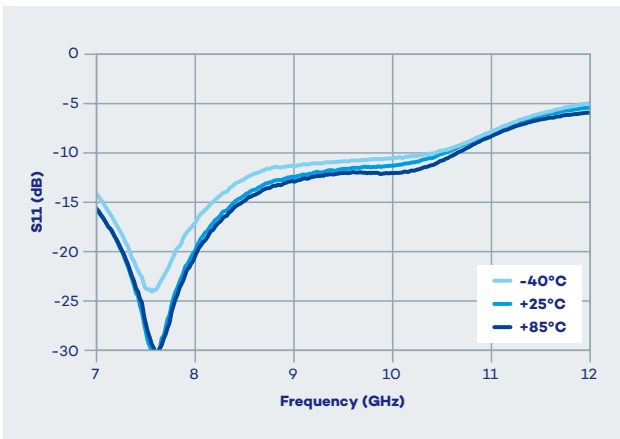
**Gain vs Frequency vs Temperature**



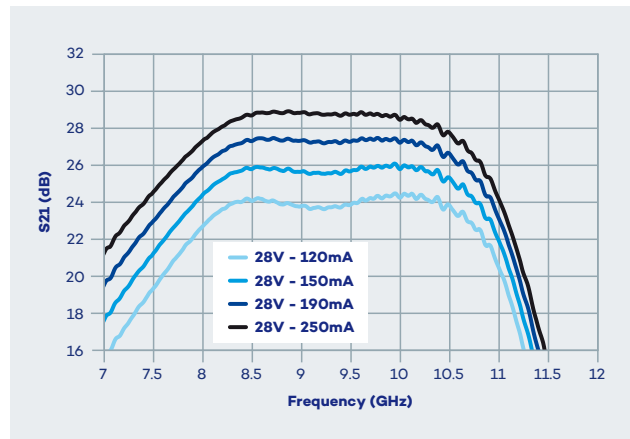
**Gain vs Frequency vs  $V_D$**



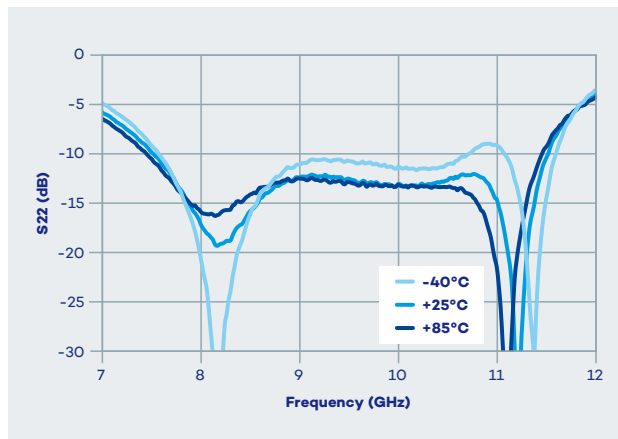
**Input Return Loss vs Frequency vs Temperature**



**Gain vs Frequency vs  $I_{BQ}$**



**Output Return Loss vs Frequency vs Temperature**

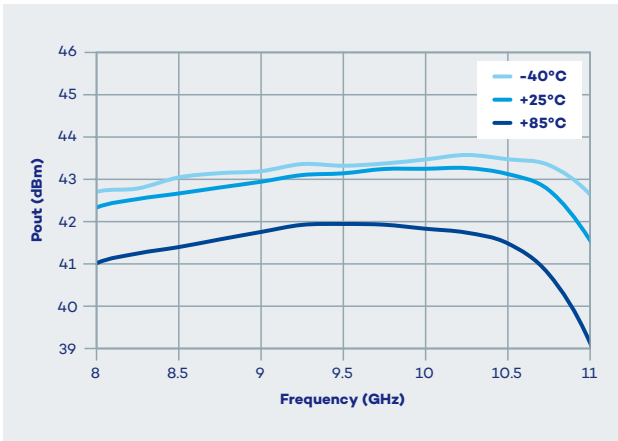


• **Typical Performance**  
(Large signal / Board Measurement)

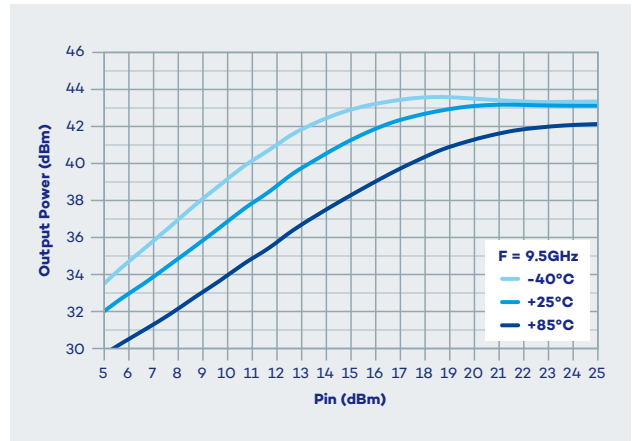
Test conditions: unless otherwise specified

- Reference plane: component access
- $V_D = +28V$
- $I_{BQ} = 190mA$  ( $V_G = -2.35V$  Typ.)
- $P_{in} = +23dBm$
- Pulsed mode (pulse width:  $30\mu s$ , duty cycle: 10%)

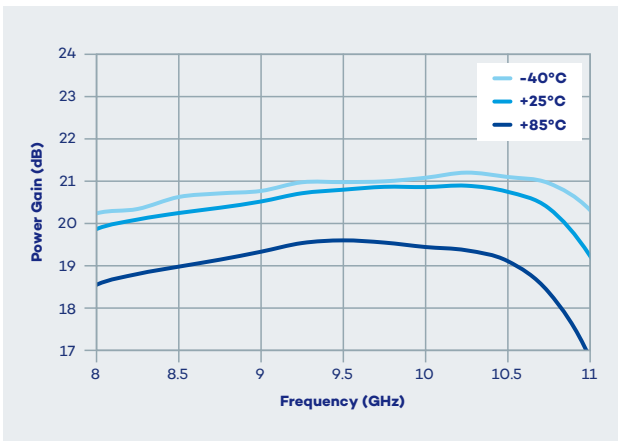
**Output Power vs Frequency vs Temperature**



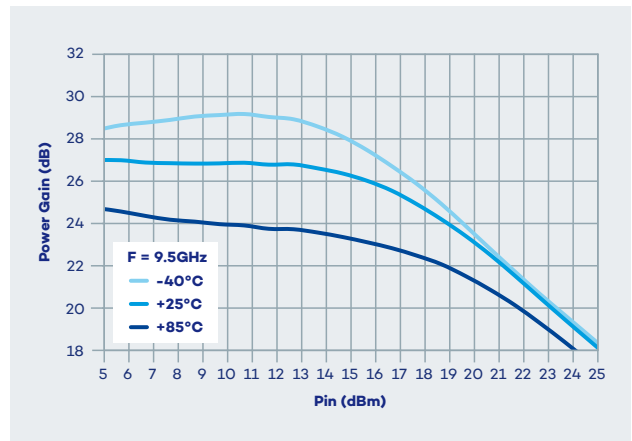
**Output Power vs Input Power vs Temperature**



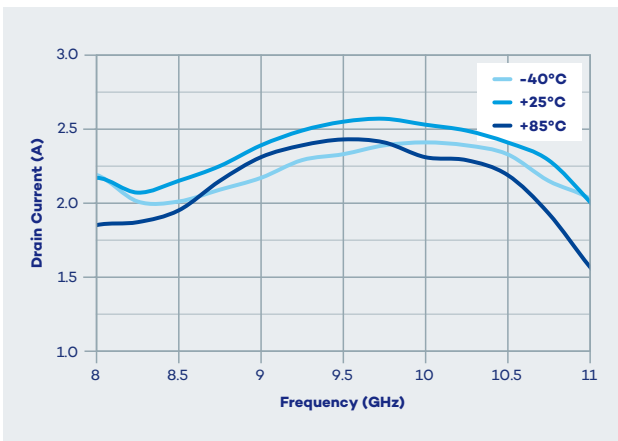
**Power Gain vs Frequency vs Temperature**



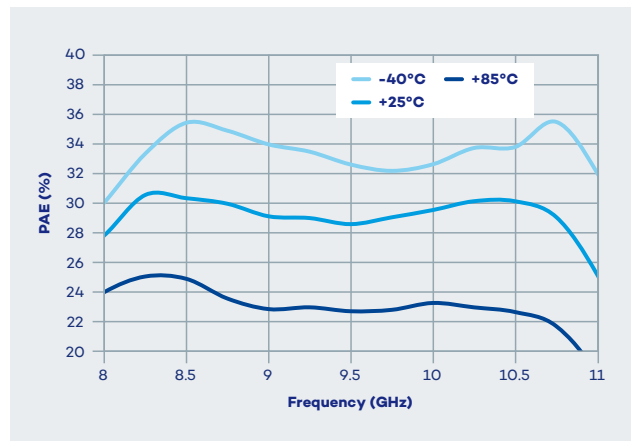
**Gain vs Input Power vs Temperature**



**Drain Current vs Frequency vs Temperature**



**PAE vs Frequency vs Temperature**

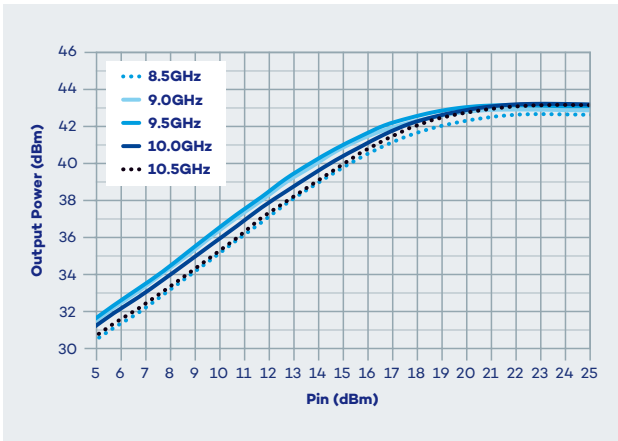


• **Typical Performance**  
(Large signal / Board Measurement)

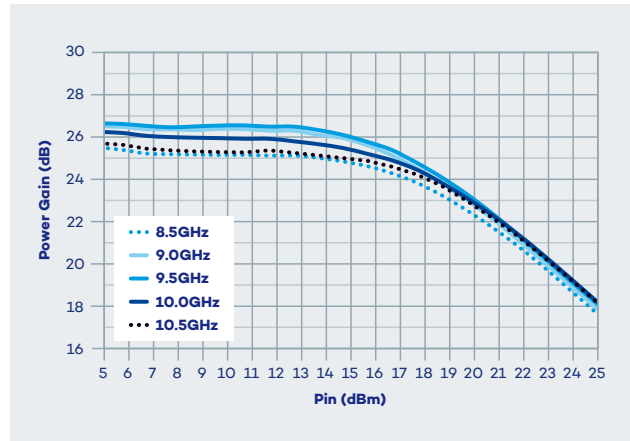
Test conditions: unless otherwise specified

- Reference plane: component access
- $V_D = +28V$
- $I_{DQ} = 190mA$  ( $V_G = -2.35V$  Typ.)
- $T_{amb} = +25^\circ C$
- Pulsed mode (pulse width:  $30\mu s$ , duty cycle: 10%)

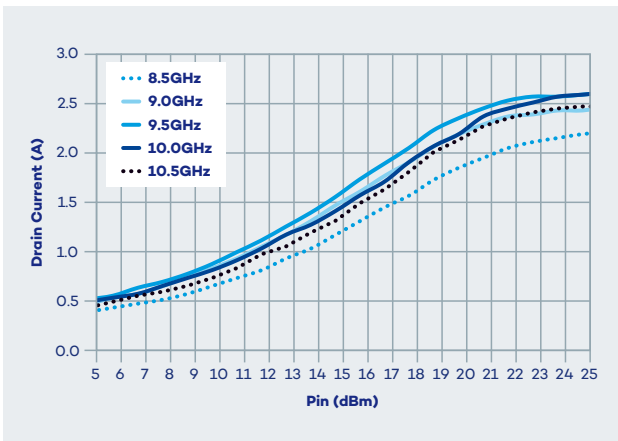
**Output Power vs Input Power vs Frequency**



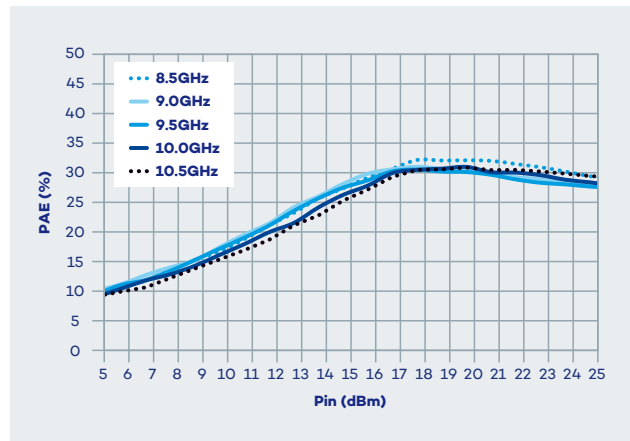
**Gain vs Input Power vs Frequency**



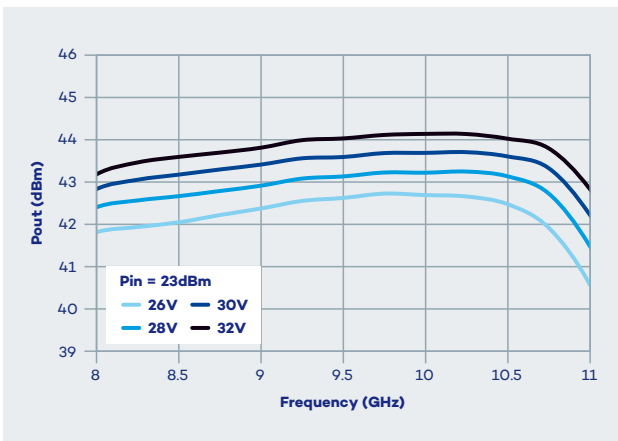
**Drain Current vs Input Power vs Frequency**



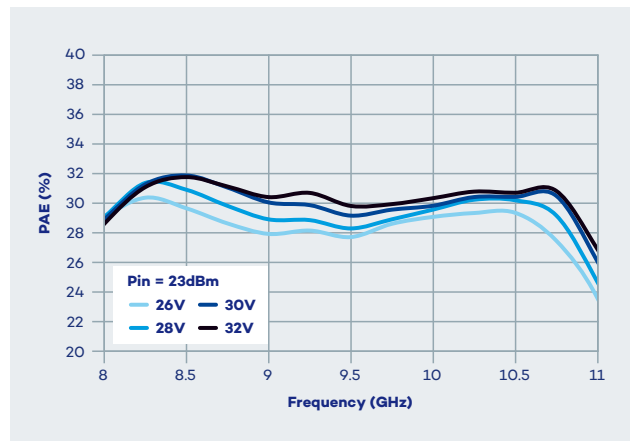
**PAE vs Input Power vs Frequency**



**Output Power vs Frequency vs  $V_D$**



**PAE vs Frequency vs  $V_D$**

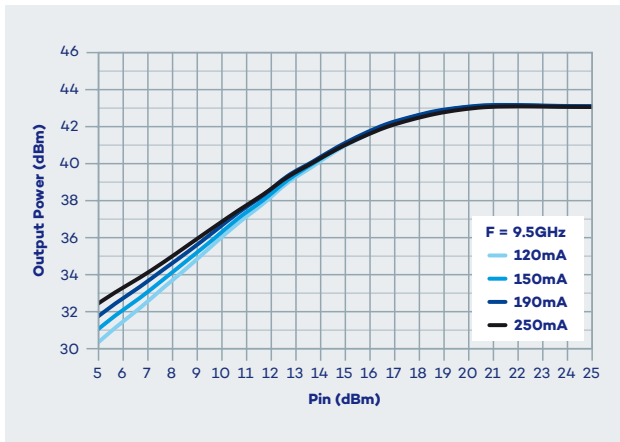


• **Typical Performance**  
(Large signal / Board Measurement)

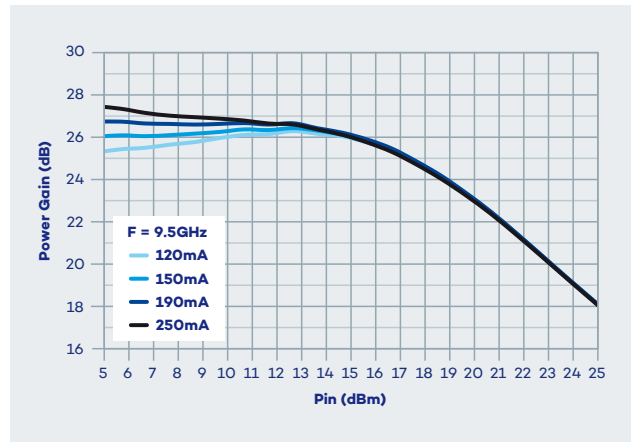
Test conditions: unless otherwise specified

- Reference plane: component access
- $V_D = +28V$
- $T_{amb} = +25^\circ C$
- Pulsed mode (pulse width: 30 $\mu s$ , duty cycle: 10%)

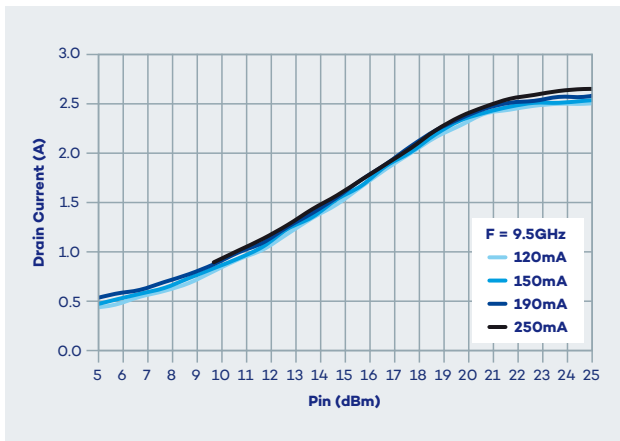
**Output Power vs Input Power vs  $I_{DQ}$**



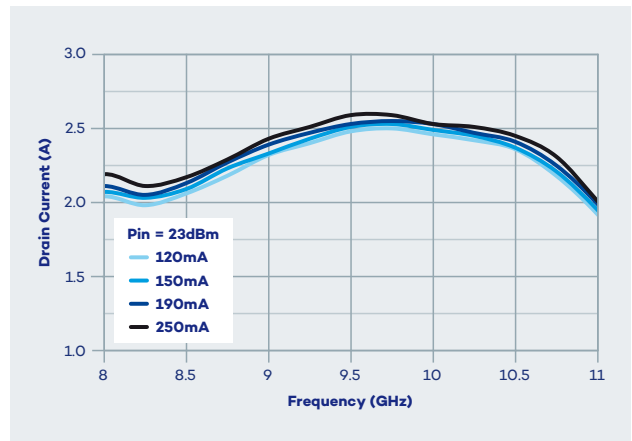
**Gain vs Input Power vs  $I_{DQ}$**



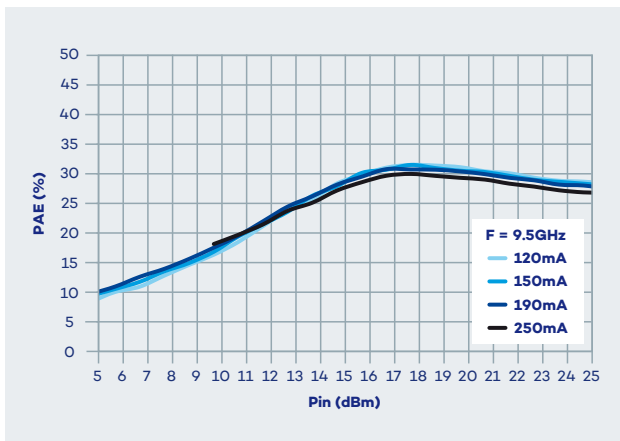
**Drain Current vs Input Power vs  $I_{DQ}$**



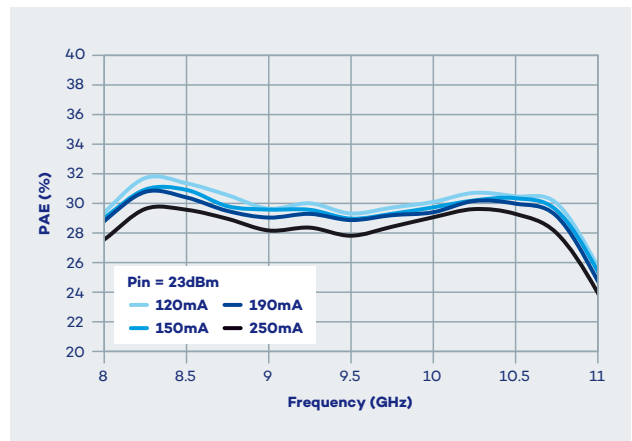
**Drain Current vs Frequency vs  $I_{DQ}$**



**PAE vs Input Power vs  $I_{DQ}$**

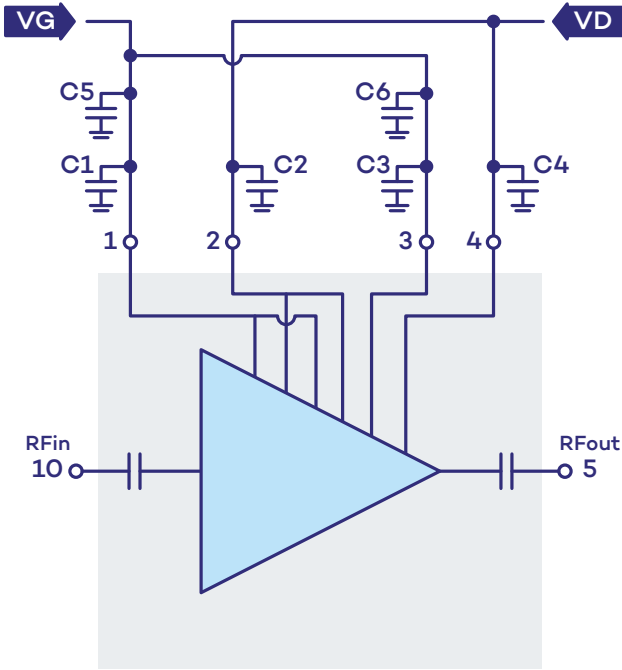


**PAE vs Frequency vs  $I_{DQ}$**



• **Application circuit**

- C1 to C4 = 1μF (50V/0603)
- C5, C6 = 100μF (16V/0805)



• **Bias-up procedure**

1. Apply  $V_G = -3V$
2. Apply  $V_D = +28V$
3. Adjust  $V_G$  to obtain the specified  $I_{BQ} = 190\text{ mA}$  ( $V_G = -2.35V$  Typ.)
4. Apply RF signal in pulsed mode

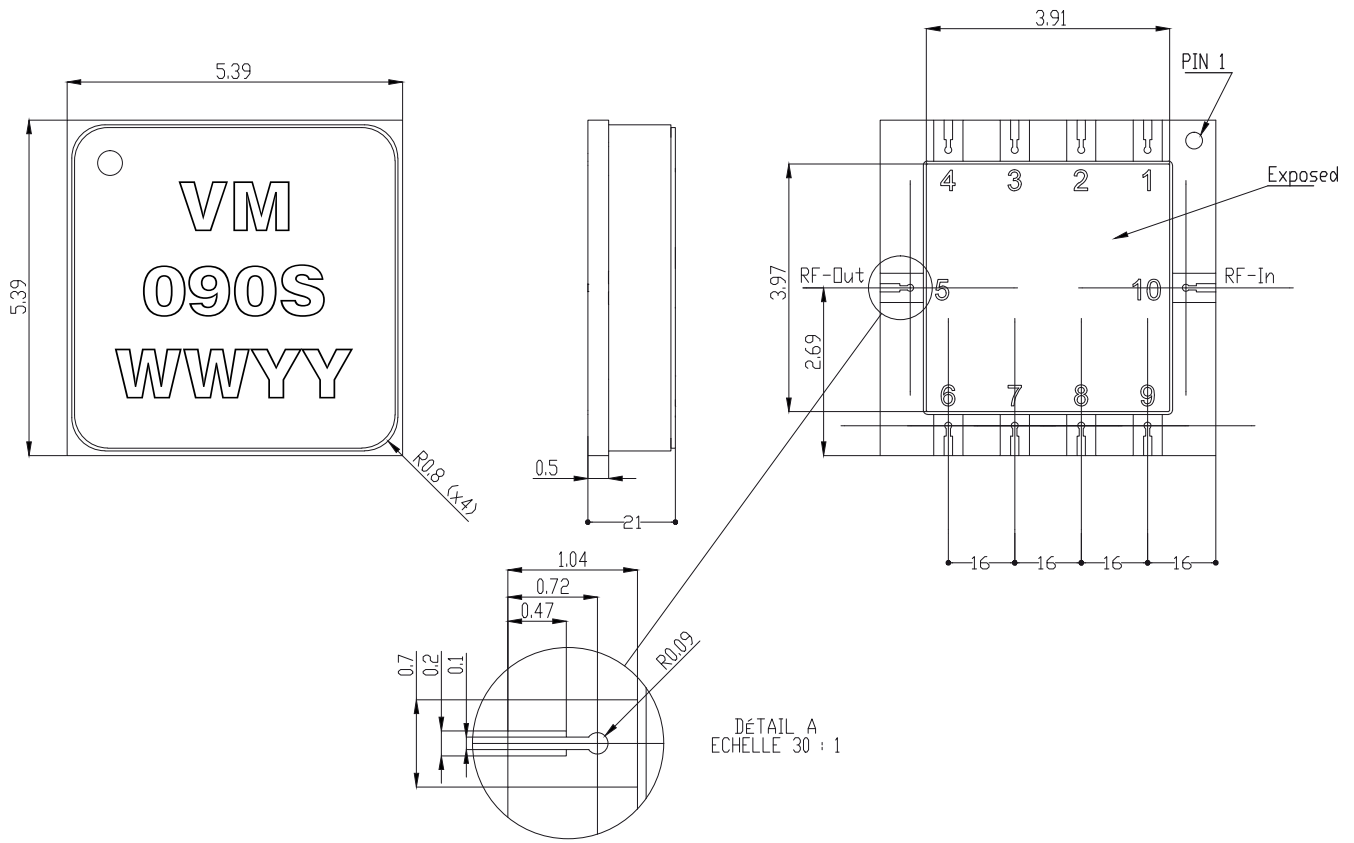
• **Bias-down procedure**

1. Turn off RF signal
2. Reduce  $V_G = -3V$
3. Apply  $V_D = 0V$
4. Turn off power supply

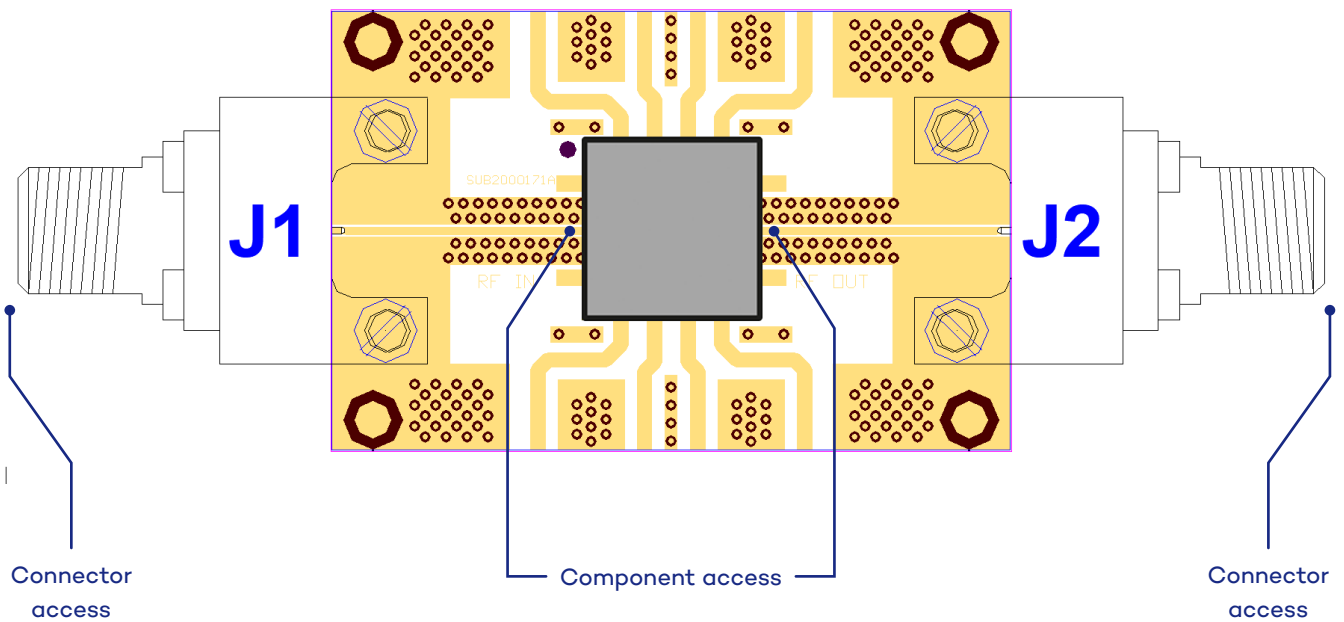
• **Pin description**

Pin number	Name	Description	Electrical interface
10	RF in	Amplifier input, this access is AC coupled and internally matched to 50 Ohms	
1, 3	$V_{G1,2}, V_{G3}$	HPA Gate biasing input accesses	
2, 4	$V_{D1,2}, V_{D3}$	HPA Drain biasing input accesses	
5	RF out	Amplifier output, this access is AC coupled and internally matched to 50 Ohms	
Exposed Pad	Gnd	Die must be connected to RF and DC Ground	

• Mechanical drawing



• Evaluation Board (EVB) Layout Assembly





## • Ordering information

Product Code	Parameter
VM090S	8.5 to 10.5GHz - 18W GaN Power Amplifier Hermetic QFN 8 x 8 (mm) 10leads

## • Associated Material

- Evaluation Board
- Mechanical files (DXF)

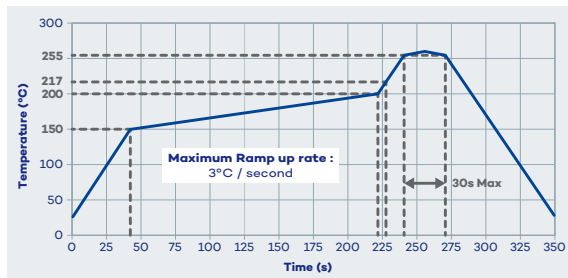
## • Product Compliance Information

### Solderability

Solder Stencil thickness: 127µm

Solder: SAC 305 (ROHS)

Temperature profile example: maximum recommended reflow profile (leadfree)



### RoHS-Compliance

This part is compliant with EU 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment).

### Other attributes

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C15H12Br4O2) Free
- PFOS Free
- SVHC Free

### ESD Sensitivity Rating

Test: Human Body Model (HBM)

Std: JEDEC Standard JESD22-A114



## • Contact information

For the latest specifications, additional product information, worldwide sales and distribution locations, and information about Vectrawave.

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